

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT2729570

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>MARIE DENISON</td> <td>01/20/2014</td> </tr> <tr> <td>BRIAN ASHLEY CARPENTER</td> <td>12/13/2013</td> </tr> <tr> <td>OSVALDO JORGE LOPEZ</td> <td>10/28/2013</td> </tr> <tr> <td>JUAN ALEJANDRO HERBSOMMER</td> <td>10/28/2013</td> </tr> <tr> <td>JONATHON NOQUIL</td> <td>10/28/2013</td> </tr> </tbody> </table>		Name	Execution Date	MARIE DENISON	01/20/2014	BRIAN ASHLEY CARPENTER	12/13/2013	OSVALDO JORGE LOPEZ	10/28/2013	JUAN ALEJANDRO HERBSOMMER	10/28/2013	JONATHON NOQUIL	10/28/2013
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JUAN ALEJANDRO HERBSOMMER	10/28/2013												
JONATHON NOQUIL	10/28/2013												
RECEIVING PARTY DATA													
Name:	TEXAS INSTRUMENTS INCORPORATED												
Street Address:	PO BOX 655474, M/S 3999												
City:	DALLAS												
State/Country:	TEXAS												
Postal Code:	75265												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14181966</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14181966								
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Application Number:	14181966												
CORRESPONDENCE DATA													
Fax Number:	(214)479-1273												
Phone:	2144791247												
Email:	uspto@ti.com												
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>													
Correspondent Name:	TEXAS INSTRUMENTS INCORPORATED												
Address Line 1:	PO BOX 655474, M/S 3999												
Address Line 4:	DALLAS, TEXAS 75265												
ATTORNEY DOCKET NUMBER:	TI-71868												
NAME OF SUBMITTER:	STEVEN A. SHAW												

Signature:	/Steven A. Shaw/
Date:	02/17/2014
Total Attachments: 9 source=TI-71868-Executed-Assg-All#page1.tif source=TI-71868-Executed-Assg-All#page2.tif source=TI-71868-Executed-Assg-All#page3.tif source=TI-71868-Executed-Assg-All#page4.tif source=TI-71868-Executed-Assg-All#page5.tif source=TI-71868-Executed-Assg-All#page6.tif source=TI-71868-Executed-Assg-All#page7.tif source=TI-71868-Executed-Assg-All#page8.tif source=TI-71868-Executed-Assg-All#page9.tif	

Application No. 14/181,966

Attorney Docket No. TI-71868

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to U.S. Provisional Application No(s). 61/810,860, filed 04-11-2013;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date hereinbelow.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

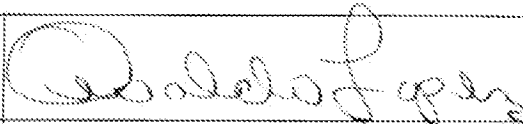
TITLE	Integrating Multi-Output Power Converters Having Vertically Stacked Semiconductor Chips		
NONPROVISIONAL APPLICATION NO.	14/181,966	FILING DATE	2014-02-17

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Marie Denison
DATE	
RESIDENCE (CITY AND STATE)	Plano, Texas

Application No. 14/181,966

Attorney Docket No. TI-71868

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Brian Ashley Carpenter
DATE	
RESIDENCE (CITY AND STATE)	Cary, North Carolina

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Osvaldo Jorge Lopez
DATE	10/28/13
RESIDENCE (CITY AND STATE)	Annandale, New Jersey

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Juan Alejandro Herbsommer
DATE	
RESIDENCE (CITY AND STATE)	Allen, Texas

Assignment From Inventor (US 9/1/09)

PATENT
REEL: 032229 FRAME: 0676

Application No. 14/181,966

Attorney Docket No. TI-71868

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Jonathon Noquil
DATE	
RESIDENCE (CITY AND STATE)	Bethlehem, Pennsylvania

After recording, return Assignment to:

Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265

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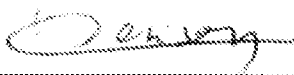
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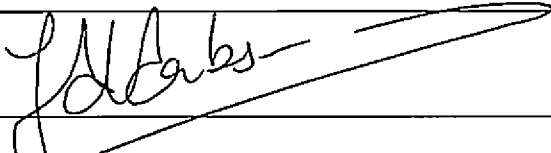
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DATE	01/20/2014
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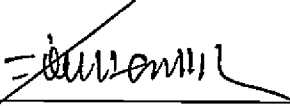
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PRINTED NAME OF INVENTOR	Juan Alejandro Herbsommer
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RESIDENCE (CITY AND STATE)	Allen, Texas

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DATE	13 DEC 2013
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